



+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$, 35Mbps, 8-Channel Level Translators

General Description

The MAX3000E/MAX3001E/MAX3002–MAX3012 8-channel level translators provide the level shifting necessary to allow data transfer in a multivoltage system. Externally applied voltages, V_{CC} and V_L , set the logic levels on either side of the device. Logic signals present on the V_L side of the device appear as a higher voltage logic signal on the V_{CC} side of the device, and vice-versa.

The MAX3000E/MAX3001E/MAX3002/MAX3003 use an architecture specifically designed to be bidirectional without the use of a directional pin.

The MAX3000E/MAX3001E/MAX3002/MAX3004–MAX3012 feature an EN input that, when low, reduces the V_{CC} and V_L supply currents to $< 2\mu\text{A}$. The MAX3000E/MAX3001E also have $\pm 15\text{kV}$ ESD protection on the I/O V_{CC} side for greater protection in applications that route signals externally. The MAX3000E operates at a guaranteed data rate of 230kbps. The MAX3001E operates at a guaranteed data rate of 4Mbps. The MAX3002–MAX3012 operate at a guaranteed data rate of 20Mbps over the entire specified operating voltage range.

The MAX3000E/MAX3001E/MAX3002–MAX3012 accept V_L voltages from +1.2V to +5.5V and V_{CC} voltages from +1.65V to +5.5V, making them ideal for data transfer between low-voltage ASICs/PLDs and higher voltage systems. The MAX3000E/MAX3001E/MAX3002–MAX3012 are available in 20-bump UCSP™, 20-pin TQFN (5mm x 5mm), and 20-pin TSSOP packages.

Applications

CMOS Logic-Level Translation
 Cellphones
 SPI™ and MICROWIRE™ Level Translation
 Low-Voltage ASIC Level Translation
 Smart Card Readers
 Cellphone Cradles
 Portable POS Systems
 Portable Communication Devices
 Low-Cost Serial Interfaces
 GPS
 Telecommunications Equipment

UCSP is a trademark of Maxim Integrated Products, Inc.

SPI is a trademark of Motorola, Inc.

MICROWIRE is a trademark of National Semiconductor.

Features

- ◆ Guaranteed Data Rate Options
 230kbps (MAX3000E)
 4Mbps (MAX3001E)
 20Mbps (MAX3002–MAX3012)
- ◆ Bidirectional Level Translation Without Using a Directional Pin (MAX3000E/MAX3001E/MAX3002/MAX3003)
- ◆ Unidirectional Level Translation (MAX3004–MAX3012)
- ◆ Operation Down to +1.2V on V_L
- ◆ $\pm 15\text{kV}$ ESD Protection on I/O V_{CC} Lines (MAX3000E/MAX3001E)
- ◆ Ultra-Low $0.1\mu\text{A}$ Supply Current in Shutdown
- ◆ Low Quiescent Current ($< 10\mu\text{A}$)
- ◆ UCSP, TQFN, and TSSOP Packages

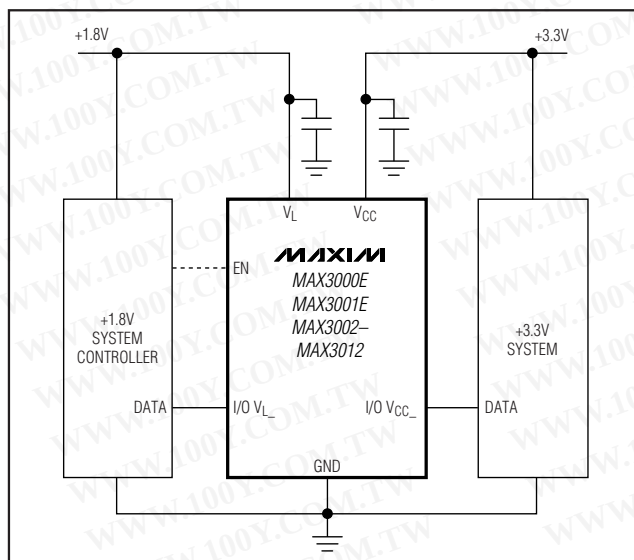
Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX3000EEUP	-40°C to +85°C	20 TSSOP
MAX3000EEBP-T	-40°C to +85°C	4 x 5 UCSP

Ordering Information continued at end of data sheet.

Note: All devices operate over the -40°C to +85°C operating temperature range.

Typical Operating Circuit



Pin Configurations and Functional Diagrams appear at end of data sheet.



+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$, 35Mbps, 8-Channel Level Translators

ABSOLUTE MAXIMUM RATINGS

(All voltages referenced to GND.)

V_{CC}	-0.3V to +6V
V_L	-0.3V to +6V
I/O $V_{CC_}$	-0.3V to ($V_{CC} + 0.3\text{V}$)
I/O V_L	-0.3V to ($V_L + 0.3\text{V}$)
EN, EN A/B	-0.3V to +6V
Short-Circuit Duration I/O V_L , I/O $V_{CC_}$ to GND	Continuous
Continuous Power Dissipation ($T_A = +70^\circ\text{C}$)	
20-Pin TSSOP (derate $7.0\text{mW}/^\circ\text{C}$ above $+70^\circ\text{C}$)	559mW
20-Bump UCSP (derate $10\text{mW}/^\circ\text{C}$ above $+70^\circ\text{C}$)	800mW
20-Pin 5mm x 5mm TQFN	
(derate $20.0\text{mW}/^\circ\text{C}$ above $+70^\circ\text{C}$)	1667mW

Operating Temperature Ranges

MAX3001EAUP	-40°C to +125°C
MAX300_EE_P	-40°C to +85°C
MAX30_E_P	-40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

($V_{CC} = +1.65\text{V}$ to $+5.5\text{V}$, $V_L = +1.2\text{V}$ to V_{CC} , EN = V_L (MAX3000E/MAX3001E/MAX3002/MAX3004-MAX3012), EN A/B = V_L or 0 (MAX3003), $T_A = T_{MIN}$ to T_{MAX} . Typical values are at $V_{CC} = +1.65\text{V}$, $V_L = +1.2\text{V}$, and $T_A = +25^\circ\text{C}$.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
POWER SUPPLIES						
V_L Supply Range	V_L		1.2		V_{CC}	V
V_{CC} Supply Range	V_{CC}		1.65		5.50	V
Supply Current from V_{CC}	I_{QVCC}	I/O $V_{CC_} = 0$, I/O $V_L = 0$ or I/O $V_{CC_} = V_{CC}$, I/O $V_L = V_L$, MAX3000E/MAX3002-MAX3012		0.1	10	μA
		I/O $V_{CC_} = 0$, I/O $V_L = 0$ or I/O $V_{CC_} = V_{CC}$, I/O $V_L = V_L$, MAX3001E		0.1	50	
Supply Current from V_L	I_{QVL}	I/O $V_{CC_} = 0$, I/O $V_L = 0$ or I/O $V_{CC_} = V_{CC}$, I/O $V_L = V_L$, MAX3000E/MAX3002-MAX3012		0.1	10	μA
		I/O $V_{CC_} = 0$, I/O $V_L = 0$ or I/O $V_{CC_} = V_{CC}$, I/O $V_L = V_L$, MAX3001E		0.1	50	
V_{CC} Shutdown Supply Current	$I_{SHDN-VCC}$	$T_A = +25^\circ\text{C}$, EN = 0, MAX3000E/MAX3001E/MAX3002/ MAX3004-MAX3012		0.1	2	μA
		$T_A = +25^\circ\text{C}$, EN A/B = 0, MAX3003		0.1	2	
V_L Shutdown Supply Current	$I_{SHDN-VL}$	$T_A = +25^\circ\text{C}$, EN = 0, MAX3000E/MAX3001E/MAX3002/ MAX3004-MAX3012		0.1	2	μA
		$T_A = +25^\circ\text{C}$, EN A/B = 0, MAX3003		0.1	2	

+1.2V to +5.5V, ±15kV ESD-Protected, 0.1µA, 35Mbps, 8-Channel Level Translators

ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = +1.65V to +5.5V, V_L = +1.2V to V_{CC}, EN = V_L (MAX3000E/MAX3001E/MAX3002/MAX3004–MAX3012), EN A/B = V_L or 0 (MAX3003), T_A = T_{MIN} to T_{MAX}. Typical values are at V_{CC} = +1.65V, V_L = +1.2V, and T_A = +25°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
I/O V _{CC} _ Three-State Output Leakage Current		T _A = +25°C, EN = 0, MAX3000E/MAX3001E/MAX3002/MAX3004–MAX3012		0.1	2	µA
		T _A = +25°C, EN A/B = 0, MAX3003		0.1	2	
I/O V _L _ Three-State Output Leakage Current		EN A/B = 0, MAX3003		0.1	2	µA
I/O V _L _ Pulldown Resistance During Shutdown		EN = 0, MAX3000E/MAX3001E/MAX3002/MAX3004–MAX3012	4.59		8.30	kΩ
EN or EN A/B Input Leakage Current		T _A = +25°C			1	µA
LOGIC-LEVEL THRESHOLDS						
I/O V _L _ Input-Voltage High Threshold	V _{IHL}				2/3 × V _L	V
I/O V _L _ Input-Voltage Low Threshold	V _{ILL}		1/3 × V _L			V
I/O V _{CC} _ Input-Voltage High Threshold	V _{IHC}				2/3 × V _{CC}	V
I/O V _{CC} _ Input-Voltage Low Threshold	V _{ILC}		1/3 × V _{CC}			V
EN, EN A/B Input-Voltage High Threshold	V _{IH}				V _L - 0.4	V
EN, EN A/B Input-Voltage Low Threshold	V _{IL}		0.4			V
I/O V _L _ Output-Voltage High	V _{OHL}	I/O V _L _ source current = 20µA, I/O V _{CC} _ ≥ V _{CC} - 0.4V	V _L - 0.4			V
I/O V _L _ Output-Voltage Low	V _{OLL}	I/O V _L _ sink current = 20µA, I/O V _{CC} _ ≤ 0.4V		0.4		V
I/O V _{CC} _ Output-Voltage High	V _{OHC}	I/O V _{CC} _ source current = 20µA, I/O V _L _ ≥ V _L - 0.4V	V _{CC} - 0.4			V
I/O V _{CC} _ Output-Voltage Low	V _{OLC}	I/O V _{CC} _ sink current = 20µA, I/O V _L _ ≤ 0.4V		0.4		V
ESD PROTECTION						
I/O V _{CC} _		Human Body Model, MAX3000E/MAX3001E		±15		kV

MAX3000E/MAX3001E/MAX3002–MAX3012

+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$, 35Mbps, 8-Channel Level Translators

TIMING CHARACTERISTICS

($V_{CC} = +1.65\text{V}$ to $+5.5\text{V}$, $V_L = +1.2\text{V}$ to V_{CC} , $EN = V_L$ (MAX3000E/MAX3001E/MAX3002/MAX3004-MAX3012), $EN\ A/B = V_L$ or 0 (MAX3003), $T_A = T_{MIN}$ to T_{MAX} . Typical values are at $V_{CC} = +1.65\text{V}$, $V_L = +1.2\text{V}$, and $T_A = +25^\circ\text{C}$.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
I/O $V_{CC_}$ Rise Time	t_{RVCC}	$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, MAX3000E, Figures 1a, 1b	400	800	1200	ns
		$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, MAX3001E, Figures 1a, 1b		25	50	
		$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, MAX3002-MAX3012, Figures 1a, 1b			15	
I/O $V_{CC_}$ Fall Time	t_{FVCC}	$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, MAX3000E, Figures 1a, 1b	400	800	1200	ns
		$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, MAX3001E, Figures 1a, 1b		25	50	
		$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, MAX3002-MAX3012, Figures 1a, 1b			15	
I/O V_L Rise Time	t_{RVL}	$R_S = 50\Omega$, $C_{VL} = 50\text{pF}$, MAX3000E, Figures 2a, 2b	400	800	1200	ns
		$R_S = 50\Omega$, $C_{VL} = 50\text{pF}$, MAX3001E, Figures 2a, 2b		25	50	
		$R_S = 50\Omega$, $C_{VL} = 15\text{pF}$, MAX3002-MAX3012, Figures 2a, 2b			15	
I/O V_L Fall Time	t_{FVL}	$R_S = 50\Omega$, $C_{VL} = 50\text{pF}$, MAX3000E, Figures 2a, 2b	400	800	1200	ns
		$R_S = 50\Omega$, $C_{VL} = 50\text{pF}$, MAX3001E, Figures 2a, 2b		25	65	
		$R_S = 50\Omega$, $C_{VL} = 15\text{pF}$, MAX3002-MAX3012, Figures 2a, 2b			15	
Propagation Delay (Driving I/O V_L)	I/O V_L -VCC	$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, MAX3000E, Figures 1a, 1b			1000	ns
		$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, MAX3001E, Figures 1a, 1b			50	
		$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, MAX3002-MAX3012, Figures 1a, 1b			20	
Propagation Delay (Driving I/O $V_{CC_}$)	I/O V_{CC} -VL	$R_S = 50\Omega$, $C_{VL} = 50\text{pF}$, MAX3000E, Figures 2a, 2b			1000	ns
		$R_S = 50\Omega$, $C_{VL} = 50\text{pF}$, MAX3001E, Figures 2a, 2b			50	
		$R_S = 50\Omega$, $C_{VL} = 15\text{pF}$, MAX3002-MAX3012, Figures 2a, 2b			20	

Note 1: All units are 100% production tested at $T_A = +25^\circ\text{C}$. Limits over the operating temperature range are guaranteed by design and not production tested.

Note 2: For normal operation, ensure that $V_L < V_{CC}$. During power-up, $V_L > V_{CC}$ does not damage the device.

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TIMING CHARACTERISTICS (continued)

($V_{CC} = +1.65\text{V}$ to $+5.5\text{V}$, $V_L = +1.2\text{V}$ to V_{CC} , $EN = V_L$ (MAX3000E/MAX3001E/MAX3002/MAX3004–MAX3012), $EN\ A/B = V_L$ or 0 (MAX3003), $T_A = T_{MIN}$ to T_{MAX} . Typical values are at $V_{CC} = +1.65\text{V}$, $V_L = +1.2\text{V}$, and $T_A = +25^\circ\text{C}$.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Channel-to-Channel Skew	t_{SKEW}	$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, $C_{VL} = 50\text{pF}$, MAX3000E			500	ns
		$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, $C_{VL} = 50\text{pF}$, MAX3001E			10	
		$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, $C_{VL} = 15\text{pF}$, MAX3002–MAX3012			5	
Part-to-Part Skew	t_{PPSKEW}	$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, $C_{VL} = 50\text{pF}$, $\Delta T_A = +20^\circ\text{C}$, MAX3000E (Note 3)			800	ns
		$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, $C_{VL} = 50\text{pF}$, $\Delta T_A = +20^\circ\text{C}$, MAX3001E (Note 3)			30	
		$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, $C_{VL} = 15\text{pF}$, $\Delta T_A = +20^\circ\text{C}$, MAX3002–MAX3012 (Note 3)			10	
Propagation Delay from I/O V_L to I/O V_{CC} after EN	t_{EN-VCC}	$C_{VCC} = 50\text{pF}$, MAX3000E/MAX3001E, MAX3002–MAX3012, Figure 3			2	μs
Propagation Delay from I/O V_{CC} to I/O V_L after EN	t_{EN-VL}	$C_{VL} = 50\text{pF}$, MAX3000E/MAX3001E/MAX3002/MAX3004–MAX3012, Figure 4			2	μs
		$C_{VL} = 15\text{pF}$, MAX3003, Figure 4			2	
Maximum Data Rate		$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, $C_{VL} = 50\text{pF}$, MAX3000E	230			kbps
		$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, $C_{VL} = 50\text{pF}$, MAX3001E	4			Mbps
		$R_S = 50\Omega$, $C_{VCC} = 50\text{pF}$, $C_{VL} = 15\text{pF}$, MAX3002–MAX3012	20			

Note 3: V_{CC} from device 1 must equal V_{CC} of device 2; V_L from device 1 must equal V_L of device 2.

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MAX3000E/MAX3001E/MAX3002–MAX3012

+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$, 35Mbps, 8-Channel Level Translators

TIMING CHARACTERISTICS—MAX3002–MAX3012

($V_{CC} = +1.65\text{V}$ to $+5.5\text{V}$, $V_L = +1.2\text{V}$ to V_{CC} , $EN = V_L$ (MAX3002/MAX3004–MAX3012), $EN\ A/B = V_L$ or 0 (MAX3003), $T_A = T_{MIN}$ to T_{MAX} .) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
+1.2V $\leq V_L \leq V_{CC} \leq +3.3\text{V}$						
I/O V_{CC} Rise Time	t_{RVCC}				15	ns
I/O V_{CC} Fall Time	t_{FVCC}				15	ns
I/O V_L Rise Time	t_{RVL}				15	ns
I/O V_L Fall Time	t_{FVL}				15	ns
Propagation Delay	I/O V_L - V_{CC}	Driving I/O V_L			15	ns
	I/O V_{CC} - V_L	Driving I/O V_{CC}			15	
Channel-to-Channel Skew	t_{SKEW}	Each translator equally loaded			5	ns
Maximum Data Rate			20			Mbps
+2.5V $\leq V_L \leq V_{CC} \leq +3.3\text{V}$						
I/O V_{CC} Rise Time	t_{RVCC}				8.5	ns
I/O V_{CC} Fall Time	t_{FVCC}				8.5	ns
I/O V_L Rise Time	t_{RVL}				8.5	ns
I/O V_L Fall Time	t_{FVL}				8.5	ns
Propagation Delay	I/O V_L - V_{CC}	Driving I/O V_L			8.5	ns
	I/O V_{CC} - V_L	Driving I/O V_{CC}			8.5	
Channel-to-Channel Skew	t_{SKEW}	Each translator equally loaded			10	ns
Maximum Data Rate			35			Mbps
+1.8V $\leq V_L \leq V_{CC} \leq +2.5\text{V}$						
I/O V_{CC} Rise Time	t_{RVCC}				10	ns
I/O V_{CC} Fall Time	t_{FVCC}				10	ns
I/O V_L Rise Time	t_{RVL}				10	ns
I/O V_L Fall Time	t_{FVL}				10	ns
Propagation Delay	I/O V_L - V_{CC}	Driving I/O V_L			15	ns
	I/O V_{CC} - V_L	Driving I/O V_{CC}			10	
Channel-to-Channel Skew	t_{SKEW}	Each translator equally loaded			5	ns
Maximum Data Rate			30			Mbps

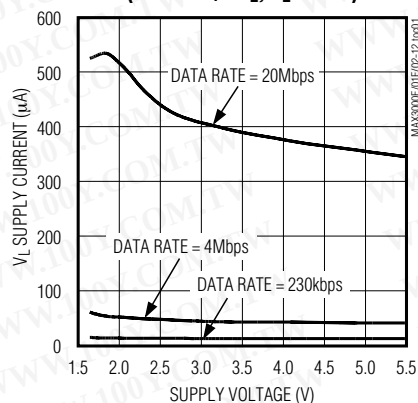
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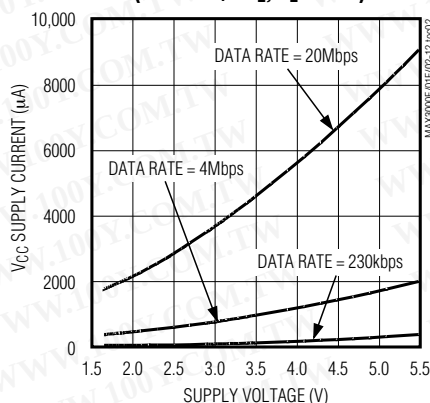
Typical Operating Characteristics

($T_A = +25^\circ\text{C}$, unless otherwise noted.)

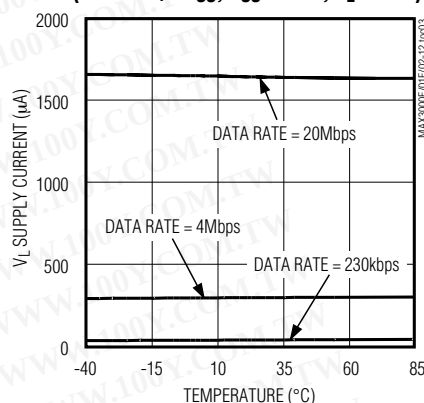
V_L SUPPLY CURRENT vs. SUPPLY VOLTAGE
 (DRIVING I/O V_L , $V_L = 1.8\text{V}$)



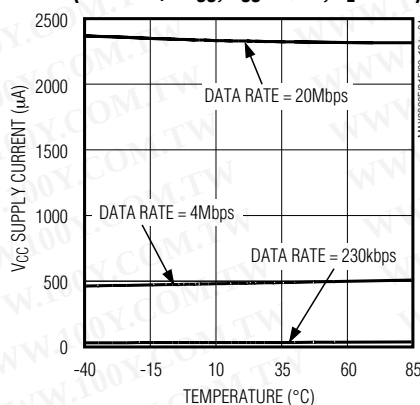
V_{CC} SUPPLY CURRENT vs. SUPPLY VOLTAGE
 (DRIVING I/O V_L , $V_L = 1.8\text{V}$)



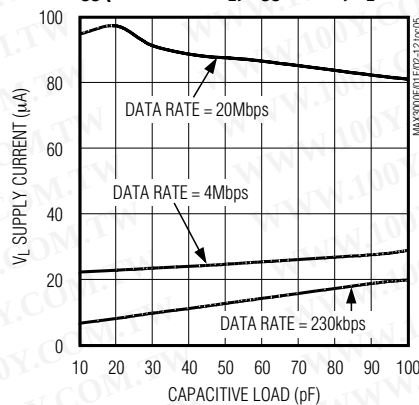
V_L SUPPLY CURRENT vs. TEMPERATURE
 (DRIVING I/O V_{CC} , $V_{CC} = 3.3\text{V}$, $V_L = 1.8\text{V}$)



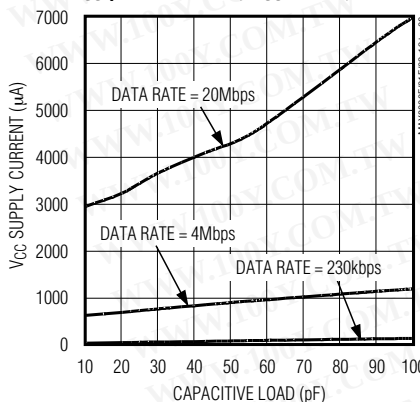
V_{CC} SUPPLY CURRENT vs. TEMPERATURE
 (DRIVING I/O V_{CC} , $V_{CC} = 3.3\text{V}$, $V_L = 1.8\text{V}$)



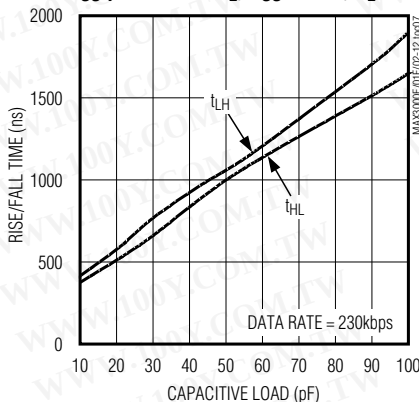
V_L SUPPLY CURRENT vs. CAPACITIVE LOAD ON I/O V_{CC} (DRIVING I/O V_L , $V_{CC} = 3.3\text{V}$, $V_L = 1.8\text{V}$)



V_{CC} SUPPLY CURRENT vs. CAPACITIVE LOAD ON I/O V_{CC} (DRIVING I/O V_L , $V_{CC} = 3.3\text{V}$, $V_L = 1.8\text{V}$)



**MAX3000E
 RISE/FALL TIME vs. CAPACITIVE LOAD ON I/O V_{CC}** (DRIVING I/O V_L , $V_{CC} = 3.3\text{V}$, $V_L = 1.8\text{V}$)



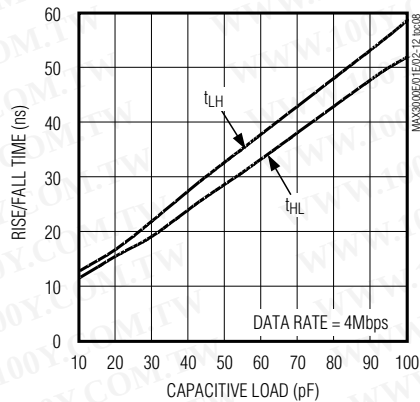
MAX3000E/MAX3001E/MAX3002-MAX3012

+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, 0.1 μA , 35Mbps, 8-Channel Level Translators

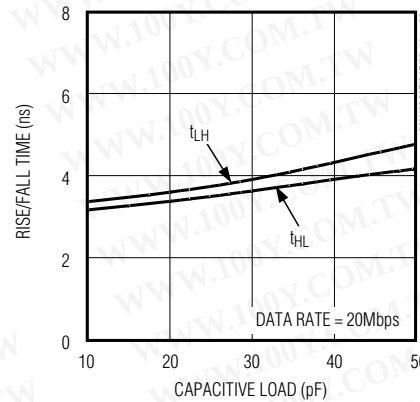
Typical Operating Characteristics (continued)

($T_A = +25^\circ\text{C}$, unless otherwise noted.)

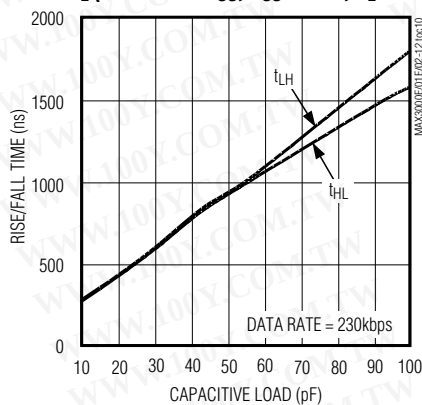
MAX3001E
 RISE/FALL TIME vs. CAPACITIVE LOAD ON
 I/O V_{CC} (DRIVING I/O V_L , $V_{CC} = 3.3\text{V}$, $V_L = 1.8\text{V}$)



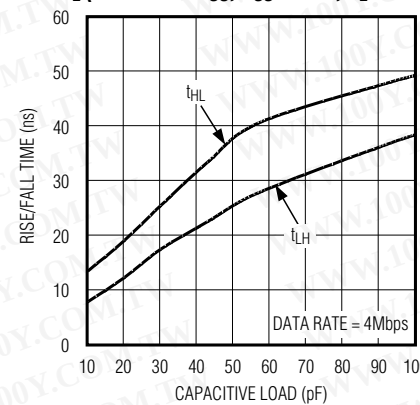
MAX3002-MAX3012
 RISE/FALL TIME vs. CAPACITIVE LOAD ON
 I/O V_{CC} (DRIVING I/O V_L , $V_{CC} = 3.3\text{V}$, $V_L = 1.8\text{V}$)



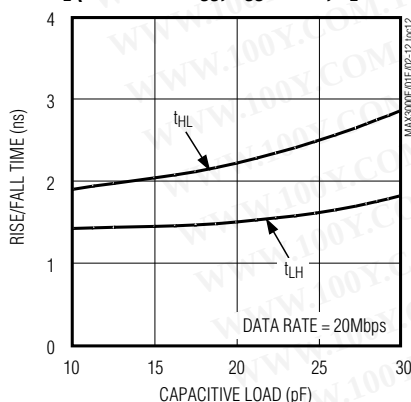
MAX3000E
 RISE/FALL TIME vs. CAPACITIVE LOAD ON
 I/O V_L (DRIVING I/O V_{CC} , $V_{CC} = 3.3\text{V}$, $V_L = 1.8\text{V}$)



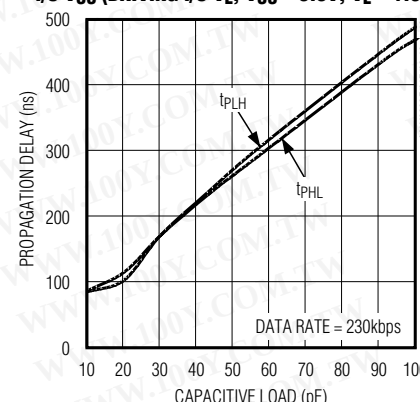
MAX3001E
 RISE/FALL TIME vs. CAPACITIVE LOAD ON
 I/O V_L (DRIVING I/O V_{CC} , $V_{CC} = 3.3\text{V}$, $V_L = 1.8\text{V}$)



MAX3002-MAX3012
 RISE/FALL TIME vs. CAPACITIVE LOAD ON
 I/O V_L (DRIVING I/O V_{CC} , $V_{CC} = 3.3\text{V}$, $V_L = 1.8\text{V}$)



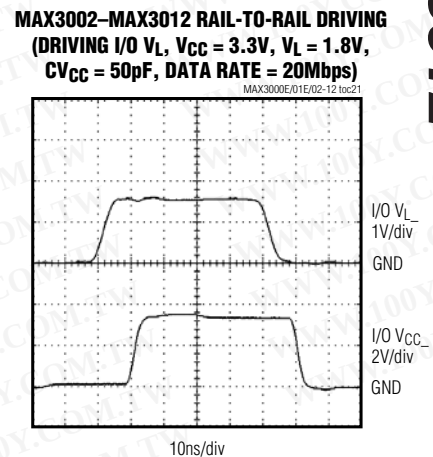
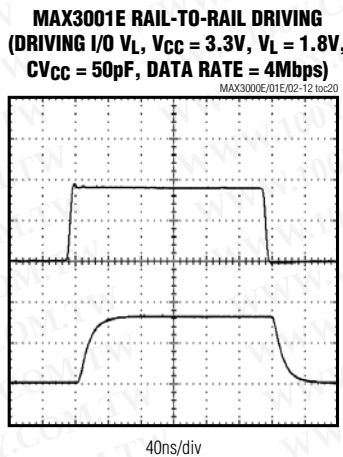
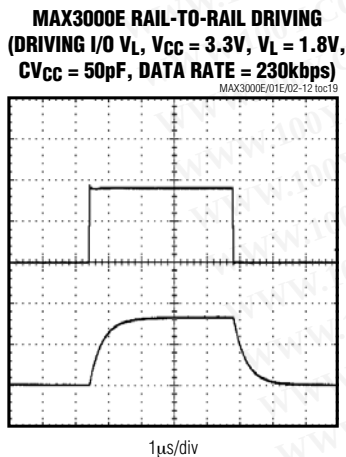
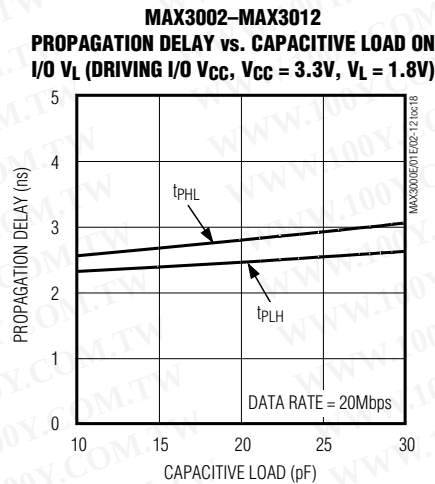
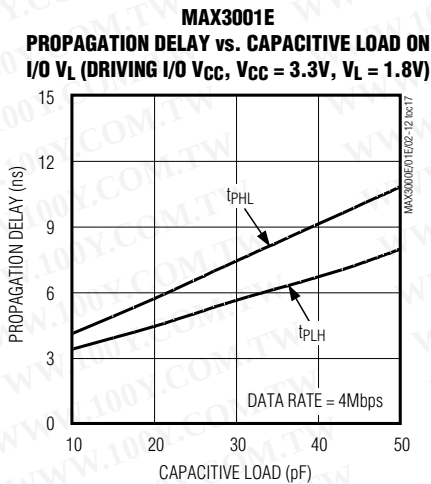
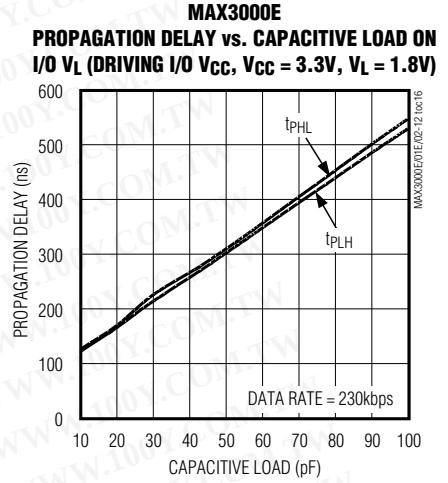
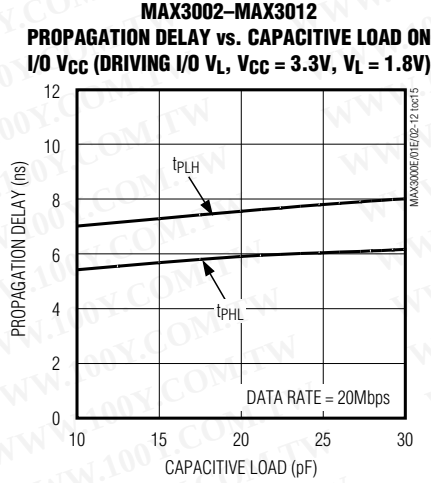
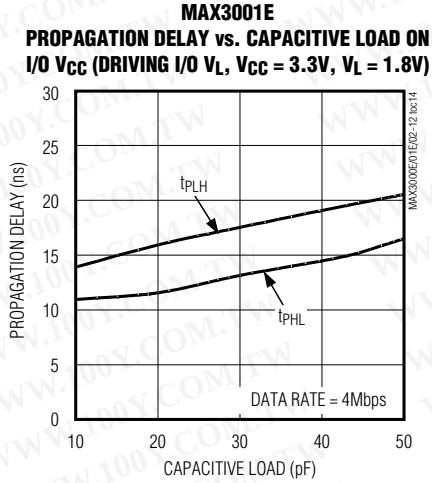
MAX3000E
 PROPAGATION DELAY vs. CAPACITIVE LOAD ON
 I/O V_{CC} (DRIVING I/O V_L , $V_{CC} = 3.3\text{V}$, $V_L = 1.8\text{V}$)



+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$, 35Mbps, 8-Channel Level Translators

Typical Operating Characteristics (continued)

($T_A = +25^\circ\text{C}$, unless otherwise noted.)



MAX3000E/MAX3001E/MAX3002-MAX3012

+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$, 35Mbps, 8-Channel Level Translators

Pin Description

MAX3000E/MAX3001E/MAX3002

PIN			NAME	FUNCTION
TSSOP	UCSP	TQFN		
1	B1	19	I/O V_L1	Input/Output 1, Referenced to V_L
2	A1	20	V_L	Logic Input Voltage, $+1.2\text{V} \leq V_L \leq V_{CC}$. Bypass V_L to GND with a $0.1\mu\text{F}$ capacitor.
3	A2	1	I/O V_L2	Input/Output 2, Referenced to V_L
4	B2	2	I/O V_L3	Input/Output 3, Referenced to V_L
5	A3	3	I/O V_L4	Input/Output 4, Referenced to V_L
6	B3	4	I/O V_L5	Input/Output 5, Referenced to V_L
7	A4	5	I/O V_L6	Input/Output 6, Referenced to V_L
8	B4	6	I/O V_L7	Input/Output 7, Referenced to V_L
9	A5	7	I/O V_L8	Input/Output 8, Referenced to V_L
10	B5	8	EN	Enable Input. If EN is pulled low, I/O $V_{CC}1$ to I/O $V_{CC}8$ are in three-state, while I/O V_L1 to I/O V_L8 have internal $6\text{k}\Omega$ pulldown resistors. Drive EN high (V_L) for normal operation.
11	C5	9	GND	Ground
12	D5	10	I/O $V_{CC}8$	Input/Output 8, Referenced to V_{CC}
13	C4	11	I/O $V_{CC}7$	Input/Output 7, Referenced to V_{CC}
14	D4	12	I/O $V_{CC}6$	Input/Output 6, Referenced to V_{CC}
15	C3	13	I/O $V_{CC}5$	Input/Output 5, Referenced to V_{CC}
16	D3	14	I/O $V_{CC}4$	Input/Output 4, Referenced to V_{CC}
17	C2	15	I/O $V_{CC}3$	Input/Output 3, Referenced to V_{CC}
18	D2	16	I/O $V_{CC}2$	Input/Output 2, Referenced to V_{CC}
19	D1	17	V_{CC}	V_{CC} Input Voltage, $+1.65\text{V} \leq V_{CC} \leq +5.5\text{V}$. Bypass V_{CC} to GND with a $0.1\mu\text{F}$ capacitor.
20	C1	18	I/O $V_{CC}1$	Input/Output 1, Referenced to V_{CC}
—	—	EP	EP	Exposed Pad. Connect to GND.

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+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$, 35Mbps, 8-Channel Level Translators

Pin Description (continued)

MAX3003

PIN			NAME	FUNCTION
TSSOP	UCSP	TQFN		
1	B1	19	I/O V_L 1A	Input/Output 1A, Referenced to V_L
2	A1	20	V_L	Logic Input Voltage, $+1.2\text{V} \leq V_L \leq V_{CC}$. Bypass V_L to GND with a $0.1\mu\text{F}$ capacitor.
3	A2	1	I/O V_L 2A	Input/Output 2A, Referenced to V_L
4	B2	2	I/O V_L 3A	Input/Output 3A, Referenced to V_L
5	A3	3	I/O V_L 4A	Input/Output 4A, Referenced to V_L
6	B3	4	I/O V_L 1B	Input/Output 1B, Referenced to V_L
7	A4	5	I/O V_L 2B	Input/Output 2B, Referenced to V_L
8	B4	6	I/O V_L 3B	Input/Output 3B, Referenced to V_L
9	A5	7	I/O V_L 4B	Input/Output 4B, Referenced to V_L
10	B5	8	EN A/B	Enable Input. If EN A/B is pulled low, channels 1B through 4B are active, and channels 1A through 4A are in three-state. If EN A/B is driven high to V_L , channels 1A through 4A are active, and channels 1B through 4B are in three-state.
11	C5	9	GND	Ground
12	D5	10	I/O V_{CC} 4B	Input/Output 4B, Referenced to V_{CC}
13	C4	11	I/O V_{CC} 3B	Input/Output 3B, Referenced to V_{CC}
14	D4	12	I/O V_{CC} 2B	Input/Output 2B, Referenced to V_{CC}
15	C3	13	I/O V_{CC} 1B	Input/Output 1B, Referenced to V_{CC}
16	D3	14	I/O V_{CC} 4A	Input/Output 4A, Referenced to V_{CC}
17	C2	15	I/O V_{CC} 3A	Input/Output 3A, Referenced to V_{CC}
18	D2	16	I/O V_{CC} 2A	Input/Output 2A, Referenced to V_{CC}
19	D1	17	V_{CC}	V_{CC} Input Voltage, $+1.65\text{V} \leq V_{CC} \leq +5.5\text{V}$. Bypass V_{CC} to GND with a $0.1\mu\text{F}$ capacitor.
20	C1	18	I/O V_{CC} 1A	Input/Output 1A, Referenced to V_{CC}
—	—	EP	EP	Exposed Pad. Connect to GND.

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MAX3000E/MAX3001E/MAX3002-MAX3012

+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, 0.1 μA , 35Mbps, 8-Channel Level Translators

Pin Description (continued)

MAX3004–MAX3012

NAME	FUNCTION (Note 1)
V _{CC}	V _{CC} Input Voltage, +1.65V < V _{CC} < +5.5V. Bypass V _{CC} to GND with a 0.1 μF capacitor.
V _L	Logic Input Voltage, +1.2V $\leq$ V _L $\leq$ V _{CC} . Bypass V _L to GND with a 0.1 μF capacitor.
GND	Ground
EN (MAX3004)	Enable Input. If EN is pulled low, OV _{CC} 1–OV _{CC} 8 are in three-state, while IV _L 1–IV _L 8 have 6k Ω pulldown resistors. Drive EN high (V _L) for normal operation.
EN (MAX3005)	Enable Input. If EN is pulled low, IV _{CC} 1 and OV _{CC} 2–OV _{CC} 8 are in three-state, while OV _L 1 and IV _L 2–IV _L 8 have 6k Ω pulldown resistors. Drive EN high (V _L) for normal operation.
EN (MAX3006)	Enable Input. If EN is pulled low, IV _{CC} 1, IV _{CC} 2, and OV _{CC} 3–OV _{CC} 8 are in three-state, while OV _L 1, OV _L 2, and IV _L 3–IV _L 8 have 6k Ω pulldown resistors. Drive EN high (V _L) for normal operation.
EN (MAX3007)	Enable Input. If EN is pulled low, IV _{CC} 1, IV _{CC} 2, IV _{CC} 3, and OV _{CC} 4–OV _{CC} 8 are in three-state, while OV _L 1, OV _L 2, OV _L 3, and IV _L 4–IV _L 8 have 6k Ω pulldown resistors. Drive EN high (V _L) for normal operation.
EN (MAX3008)	Enable Input. If EN is pulled low, IV _{CC} 1–IV _{CC} 4 and OV _{CC} 5–OV _{CC} 8 are in three-state, while OV _L 1–OV _L 4 and IV _L 5–IV _L 8 have 6k Ω pulldown resistors. Drive EN high (V _L) for normal operation.
EN (MAX3009)	Enable Input. If EN is pulled low, IV _{CC} 1–IV _{CC} 5, OV _{CC} 6, OV _{CC} 7, and OV _{CC} 8 are in three-state, while OV _L 1–OV _L 5, IV _L 6, IV _L 7, and IV _L 8 have 6k Ω pulldown resistors. Drive EN high (V _L) for normal operation.
EN (MAX3010)	Enable Input. If EN is pulled low, IV _{CC} 1–IV _{CC} 6, OV _{CC} 7, and OV _{CC} 8 are in three-state, while OV _L 1–OV _L 6, IV _L 7, and IV _L 8 have 6k Ω pulldown resistors. Drive EN high (V _L) for normal operation.
EN (MAX3011)	Enable Input. If EN is pulled low, IV _{CC} 1–IV _{CC} 7 and OV _{CC} 8 are in three-state, while OV _L 1–OV _L 7 and IV _L 8 have 6k Ω pulldown resistors. Drive EN high (V _L) for normal operation.
EN (MAX3012)	Enable Input. If EN is pulled low, IV _{CC} 1–IV _{CC} 8 are in three-state, while OV _L 1–OV _L 8 have 6k Ω pulldown resistors. Drive EN high (V _L) for normal operation.
IV _L 1–IV _L 8	Inputs Referenced to V _L , Numbers 1 to 8
OV _L 1–OV _L 8	Outputs Referenced to V _L , Numbers 1 to 8
IV _{CC} 1–IV _{CC} 8	Inputs Referenced to V _{CC} , Numbers 1 to 8
OV _{CC} 1–OV _{CC} 8	Outputs Referenced to V _{CC} , Numbers 1 to 8

Note 1: For specific pin numbers, see the *Pin Configurations*.

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+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$, 35Mbps, 8-Channel Level Translators

Test Circuits/Timing Diagrams

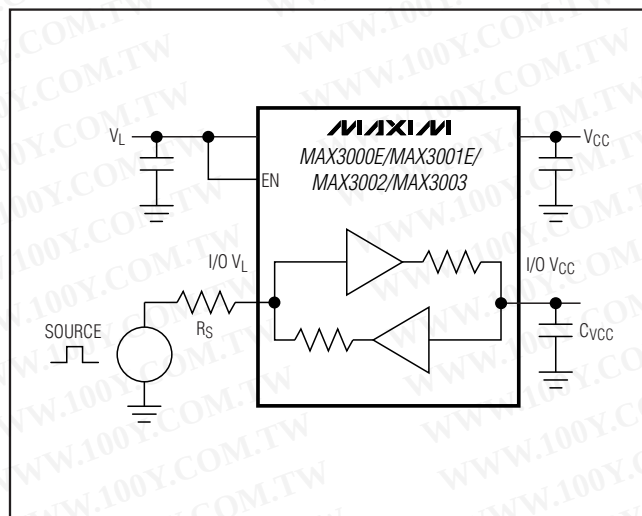


Figure 1a. Driving I/O V_L

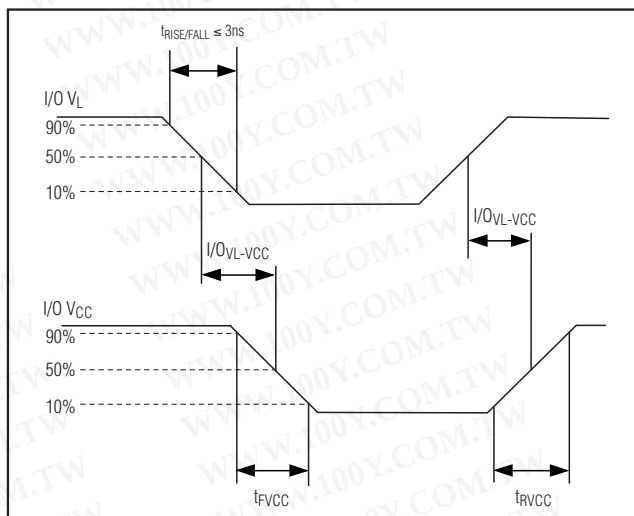


Figure 1b. Timing for Driving I/O V_L

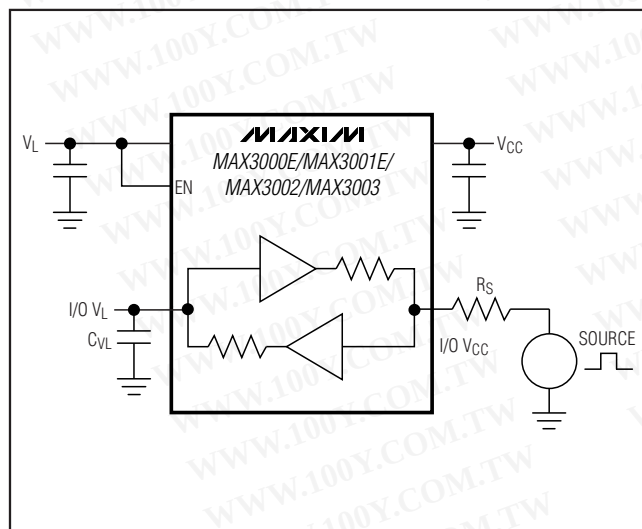


Figure 2a. Driving I/O V_{CC}

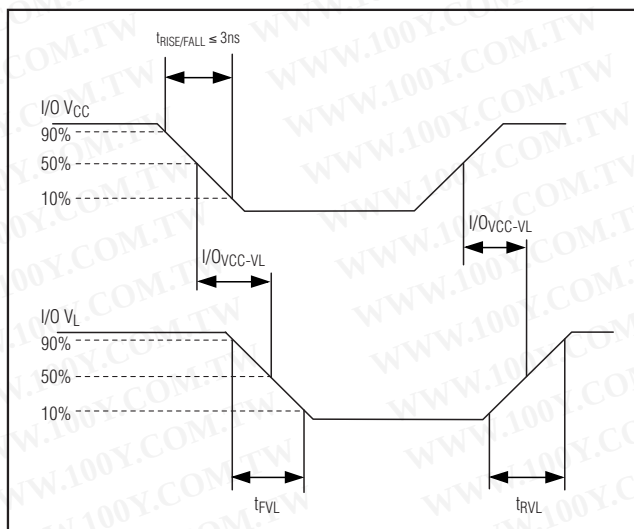


Figure 2b. Timing for Driving I/O V_{CC}

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MAX3000E/MAX3001E/MAX3002-MAX3012

+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$, 35Mbps, 8-Channel Level Translators

Test Circuits/Timing Diagrams (continued)

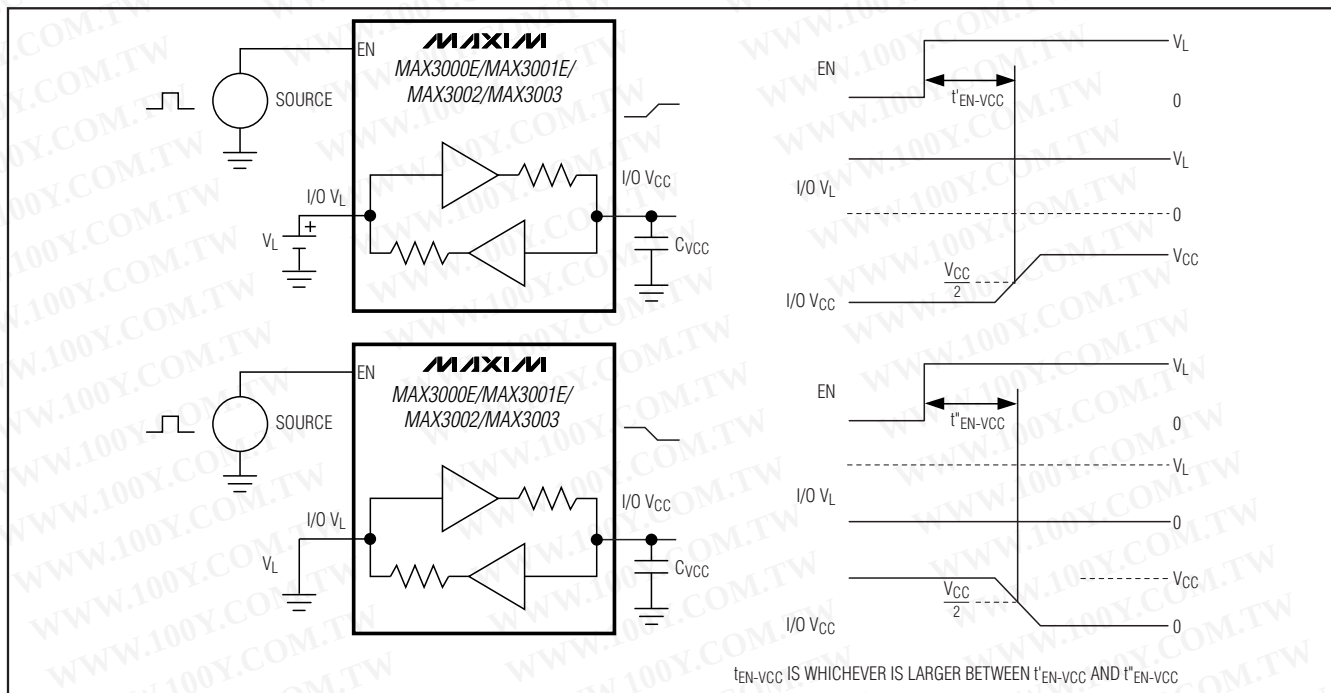


Figure 3. Propagation Delay from I/O V_L to I/O V_{CC} After EN

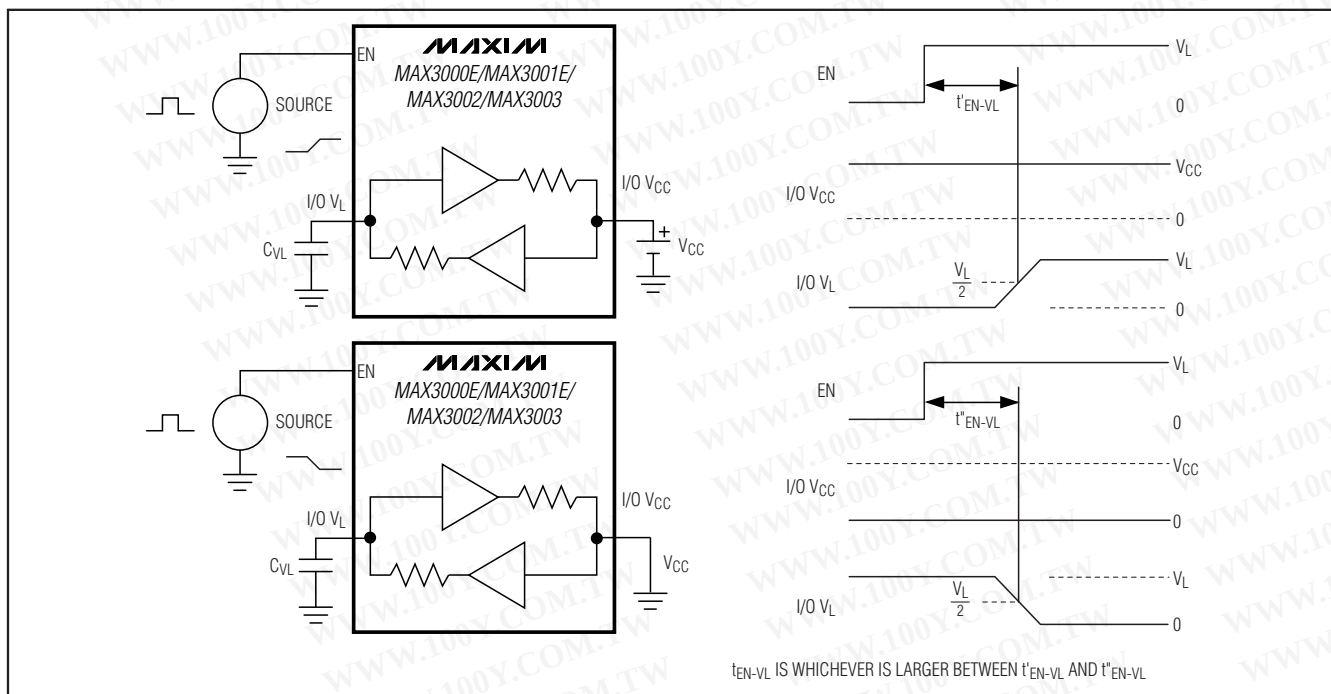


Figure 4. Propagation Delay from I/O V_{CC} to I/O V_L After EN

+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$, 35Mbps, 8-Channel Level Translators

Detailed Description

The MAX3000E/MAX3001E/MAX3002–MAX3012 logic-level translators provide the level shifting necessary to allow data transfer in a multivoltage system. Externally applied voltages, V_{CC} and V_L , set the logic levels on either side of the device. Logic signals present on the V_L side of the device appear as a higher voltage logic signal on the V_{CC} side of the device, and vice-versa. The MAX3000E/MAX3001E/MAX3002/MAX3003 are bidirectional level translators allowing data translation in either direction ($V_L \leftrightarrow V_{CC}$) on any single data line. These devices use an architecture specifically designed to be bidirectional without the use of a direction pin. The MAX3004–MAX3012 unidirectional level translators level shift data in one direction ($V_L \rightarrow V_{CC}$ or $V_{CC} \rightarrow V_L$) on any single data line. The MAX3000E/MAX3001E/MAX3002–MAX3012 accept V_L from +1.2V to +5.5V. All devices have V_{CC} ranging from +1.65V to +5.5V, making them ideal for data transfer between low-voltage ASICs/PLDs and higher voltage systems.

The MAX3000E/MAX3001E/MAX3002/MAX3004–MAX3012 feature an output enable mode that reduces V_{CC} supply current to less than $2\mu\text{A}$, and V_L supply current to less than $2\mu\text{A}$ when in shutdown. The MAX3000E/MAX3001E have $\pm 15\text{kV}$ ESD protection on the V_{CC} side for greater protection in applications that route signals externally. The MAX3000E operates at a guaranteed data rate of 230kbps; the MAX3001E operates at a guaranteed data rate of 4Mbps and the MAX3002–MAX3012 are guaranteed with a data rate of 20Mbps of operation over the entire specified operating voltage range.

Level Translation

For proper operation, ensure that $+1.65\text{V} \leq V_{CC} \leq +5.5\text{V}$, $+1.2\text{V} \leq V_L \leq +5.5\text{V}$, and $V_L \leq V_{CC}$. During power-up sequencing, $V_L \geq V_{CC}$ does not damage the device. During power-supply sequencing, when V_{CC} is floating and V_L is powering up, up to 10mA current can be sourced to each load on the V_L side, yet the device does not latch up.

The maximum data rate also depends heavily on the load capacitance (see the *Typical Operating Characteristics*), output impedance of the driver, and the operational voltage range (see the *Timing Characteristics* table).

Input Driver Requirements

The MAX3001E/MAX3002–MAX3012 architecture is based on a one-shot accelerator output stage. See Figure 5. Accelerator output stages are always in three-

state except when there is a transition on any of the translators on the input side, either I/O V_L or I/O V_{CC} .

When there is such a transition, the accelerator stages become active, charging (discharging) the capacitances at the I/Os. Due to its bidirectional nature, both stages become active during the one-shot pulse. This can lead to some current feeding into the external source that is driving the translator. However, this behavior helps to speed up the transition on the driven side.

For proper full-speed operation, the output current of a device that drives the inputs of the MAX3000E/MAX3001E/MAX3002–MAX3012 should meet the following requirements:

- MAX3000E (230kbps):
 $i > 1\text{mA}$, $R_{drv} < 1\text{k}\Omega$
- MAX3001E (4Mbps):
 $i > 10^7 \times V \times (C + 10\text{pF})$
- MAX3002–MAX3012 (20Mbps):
 $i > 10^8 \times V \times (C + 10\text{pF})$

where i is the driver output current, V is the logic-supply voltage (i.e., V_L or V_{CC}) and C is the parasitic capacitance of the signal line.

Enable Output Mode (EN, EN A/B)

The MAX3000E/MAX3001E/MAX3002 and the MAX3004–MAX3012 feature an EN input, and the MAX3003 has an EN A/B input. Pull EN low to set the MAX3000E/MAX3001E/MAX3002/MAX3004–MAX3012s' I/O $V_{CC}1$ through I/O $V_{CC}8$ in three-state output mode, while I/O V_L1 through I/O V_L8 have internal $6\text{k}\Omega$ pulldown resistors. Drive EN to logic-high (V_L) for normal operation. The MAX3003 is intended for bus multiplexing or bus switching applications. Drive EN A/B low to place channels 1B through 4B in active mode, while channels 1A through 4A are in three-state mode. Drive EN A/B to logic-high (V_L) to enable channels 1A through 4A, while channels 1B through 4B remain in three-state mode.

$\pm 15\text{kV}$ ESD Protection

As with all Maxim devices, ESD-protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The I/O V_{CC} lines have extra protection against static discharge. Maxim's engineers have developed state-of-the-art structures to protect these pins against ESD of $\pm 15\text{kV}$ without damage. The ESD structures withstand high ESD in all states: normal operation, three-state output mode, and powered down. After an ESD event, Maxim's E versions keep working without latchup, whereas competing products can latch and must be powered down to remove latchup.

+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$, 35Mbps, 8-Channel Level Translators

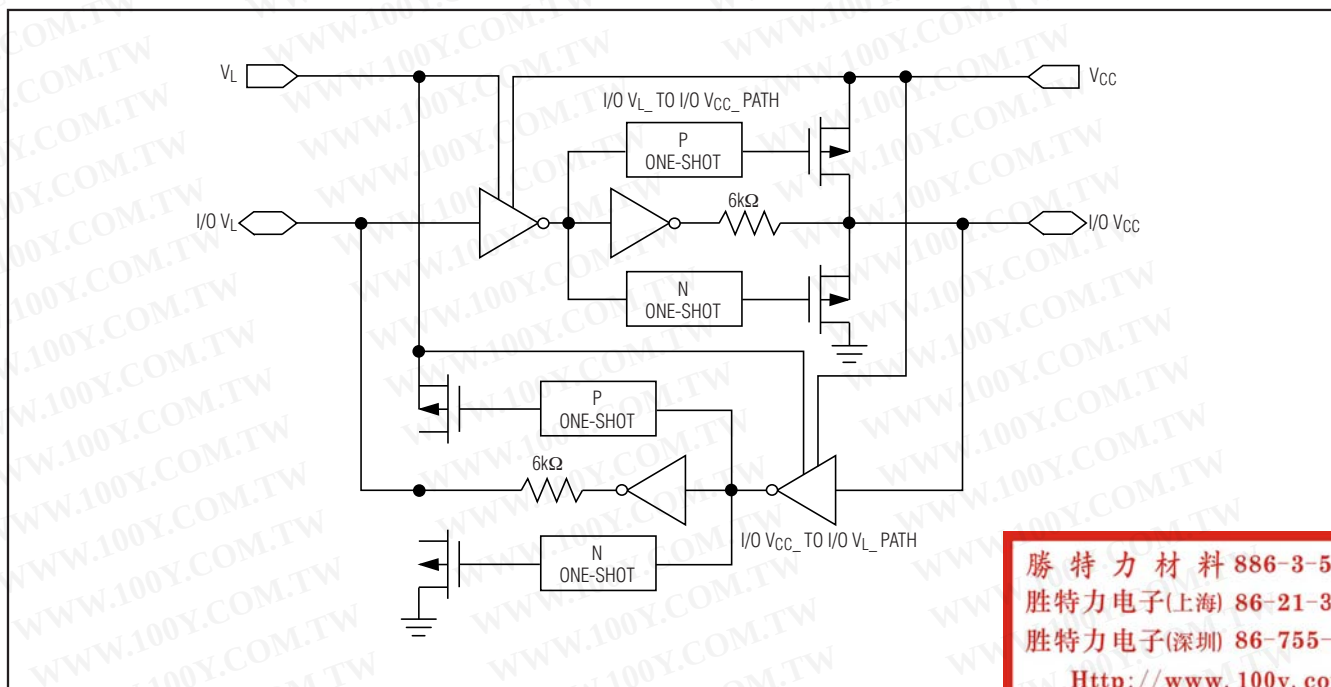


Figure 5. MAX3001E/MAX3002-MAX3012 Simplified Functional Diagram (1 I/O Line)

ESD protection can be tested in various ways. The I/O V_{CC} lines of the MAX3000E/MAX3001E are characterized for protection to $\pm 15\text{kV}$ using the Human Body Model.

ESD Test Conditions

ESD performance depends on a variety of conditions. Contact Maxim for a reliability report that documents test setup, test methodology, and test results.

Human Body Model

Figure 7a shows the Human Body Model and Figure 7b shows the current waveform it generates when discharged into a low impedance. This model consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged into the test device through a $1.5\text{k}\Omega$ resistor.

Machine Model

The Machine Model for ESD tests all pins using a 200pF storage capacitor and zero discharge resistance. Its objective is to emulate the stress caused by contact that occurs with handling and assembly during manufacturing. Of course, all pins require this protection during manufacturing, not just inputs and outputs. Therefore, after PCB assembly, the Machine Model is less relevant to I/O ports.

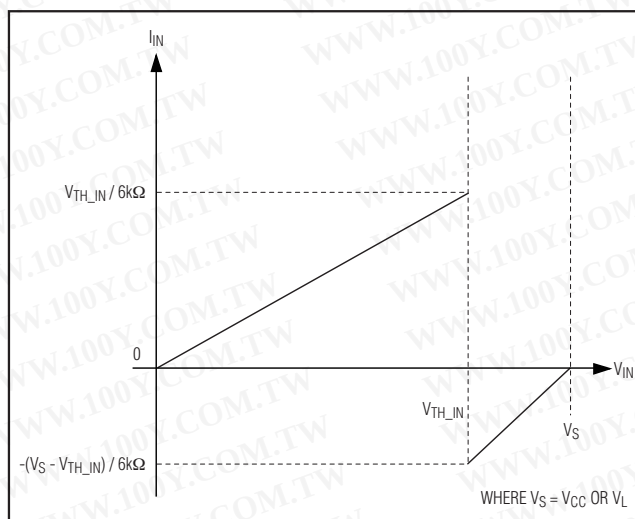


Figure 6. Typical I_{IN} vs. V_{IN}

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+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$, 35Mbps, 8-Channel Level Translators

Applications Information

Power-Supply Decoupling

To reduce ripple and the chance of transmitting incorrect data, bypass V_L and V_{CC} to ground with a $0.1\mu\text{F}$ capacitor. To ensure full $\pm 15\text{kV}$ ESD protection, bypass V_{CC} to ground with a $1\mu\text{F}$ capacitor. Place all capacitors as close to the power-supply inputs as possible.

I²C Level Translation

For I²C level translation for I²C applications, please refer to the MAX3372E–MAX3379E/MAX3390E–MAX3393E datasheet.

Unidirectional vs. Bidirectional Level Translator

The MAX3000E/MAX3001E/MAX3002/MAX3003 bidirectional translators can operate as a unidirectional device to translate signals without inversion. The MAX3004–MAX3012 unidirectional level translators, level-shift data in one direction ($V_L \rightarrow V_{CC}$ or $V_{CC} \rightarrow V_L$) on any single data line (see the *Ordering Information*.) These devices provide the smallest solution (UCSP package) for unidirectional level translation without inversion.

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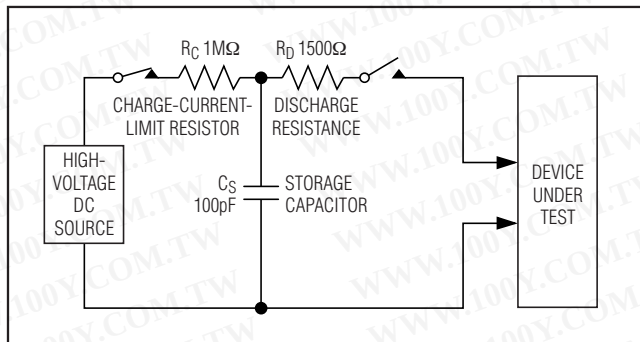


Figure 7a. Human Body ESD Test Model

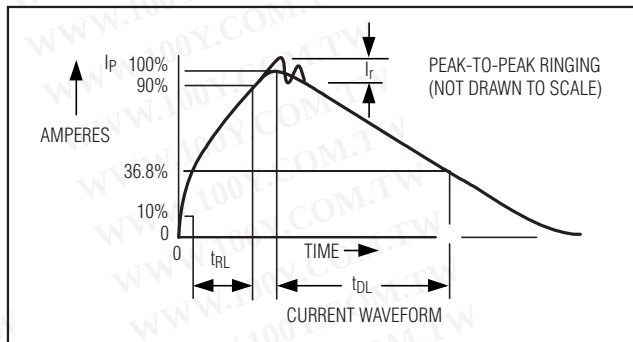


Figure 7b. Human Body Current Waveform

Selector Guide

PART	EN	EN A/B	Tx/Rx*	DATA RATE	ESD PROTECTION (kV)
MAX3000E	✓	—	8/8	230kbps	± 15
MAX3001E	✓	—	8/8	4Mbps	± 15
MAX3002	✓	—	8/8	**	± 2
MAX3003	—	✓	8/8	**	± 2
MAX3004	✓	—	8/0	**	± 2
MAX3005	✓	—	7/1	**	± 2
MAX3006	✓	—	6/2	**	± 2
MAX3007	✓	—	5/3	**	± 2
MAX3008	✓	—	4/4	**	± 2
MAX3009	✓	—	3/5	**	± 2
MAX3010	✓	—	2/6	**	± 2
MAX3011	✓	—	1/7	**	± 2
MAX3012	✓	—	0/8	**	± 2

*Tx = $V_L \rightarrow V_{CC}$; Rx = $V_{CC} \rightarrow V_L$

**See Table 1.

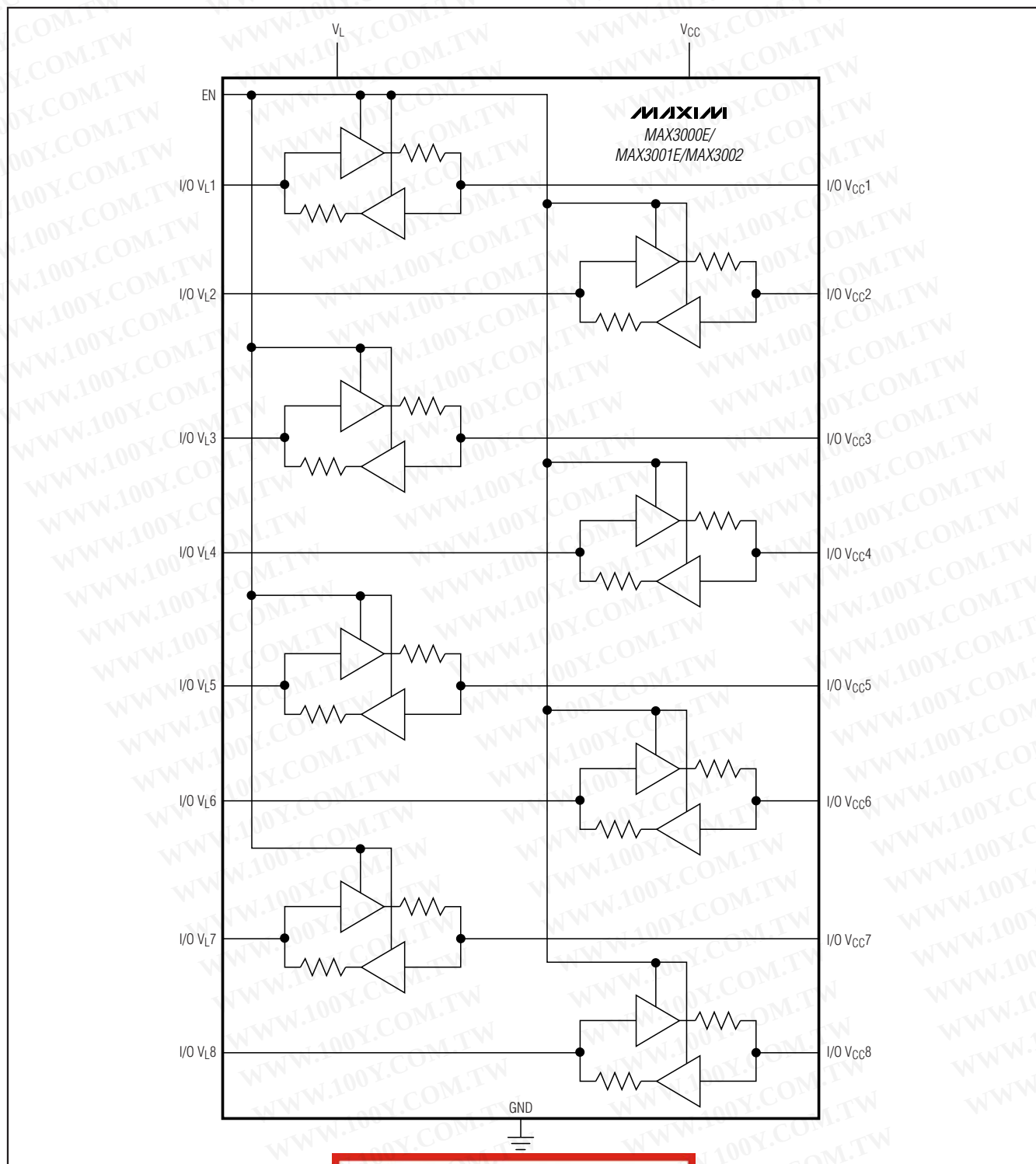
Table 1. Data Rate

$V_L \leftrightarrow V_{CC}$ (V)	MAX3002-MAX3012 GUARANTEED DATA RATE (Mbps)
1.2 $\leftrightarrow$ 5.5	40
1.2 $\leftrightarrow$ 3.3	20
2.5 $\leftrightarrow$ 3.3	35
1.8 $\leftrightarrow$ 2.5	30
1.2 $\leftrightarrow$ 2.5	20
1.2 $\leftrightarrow$ 1.8	20

勝特力材料 886-3-5753170
 勝特力电子(上海) 86-21-34970699
 勝特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)

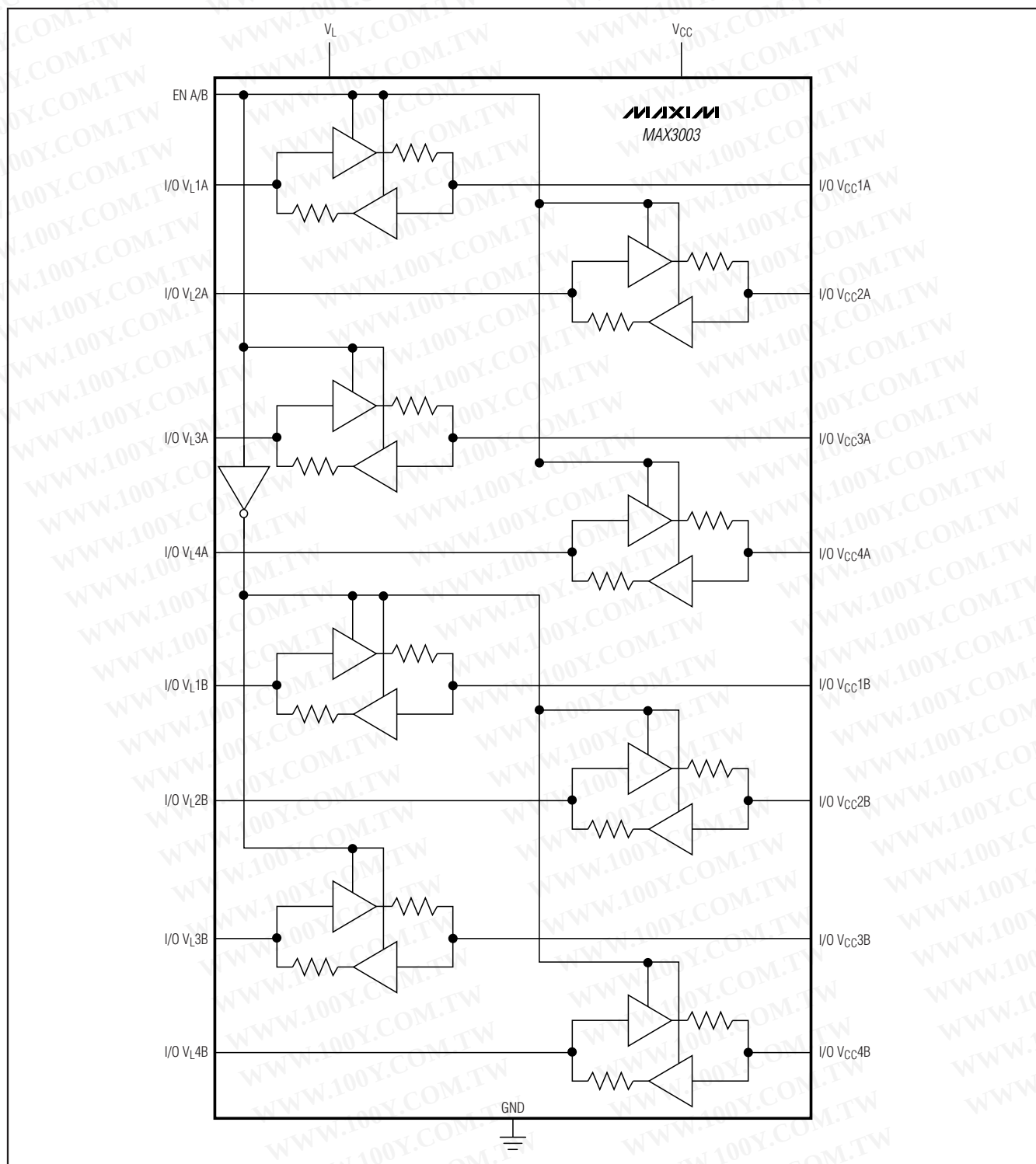
**+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$,
35Mbps, 8-Channel Level Translators**

MAX3000E/MAX3001E/MAX3002 Functional Diagram



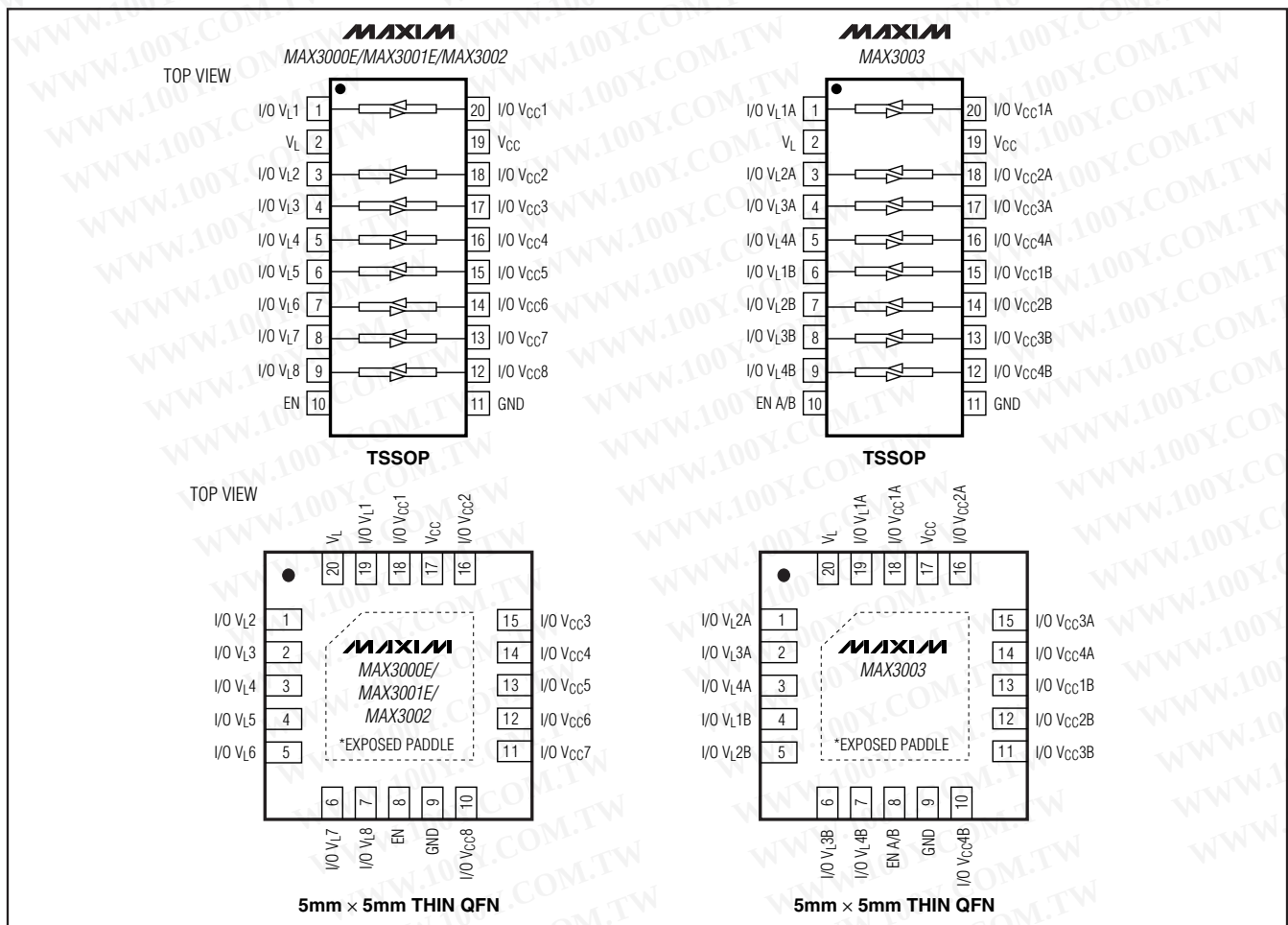
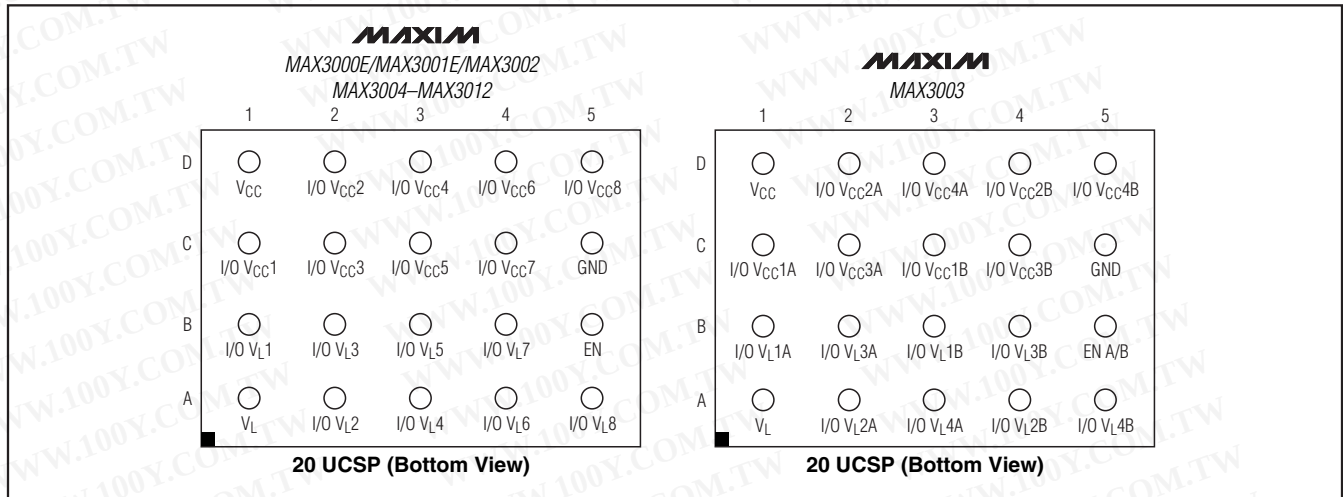
MAX3000E/MAX3001E/MAX3002-MAX3012

+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, 0.1 μA , 35Mbps, 8-Channel Level Translators

MAX3003 Functional Diagram


+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$, 35Mbps, 8-Channel Level Translators

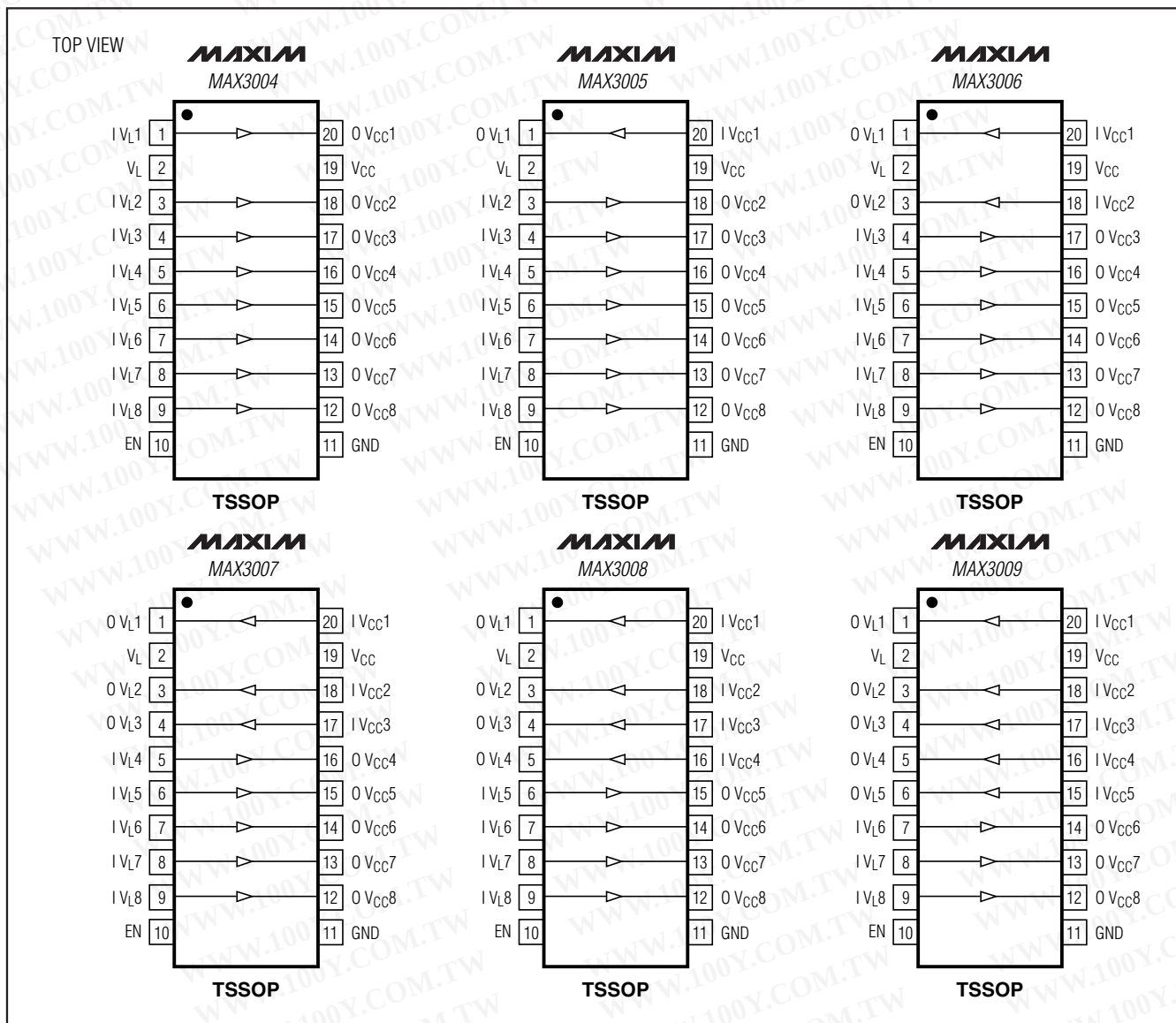
Pin Configurations



MAX3000E/MAX3001E/MAX3002-MAX3012

+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, 0.1 μA , 35Mbps, 8-Channel Level Translators

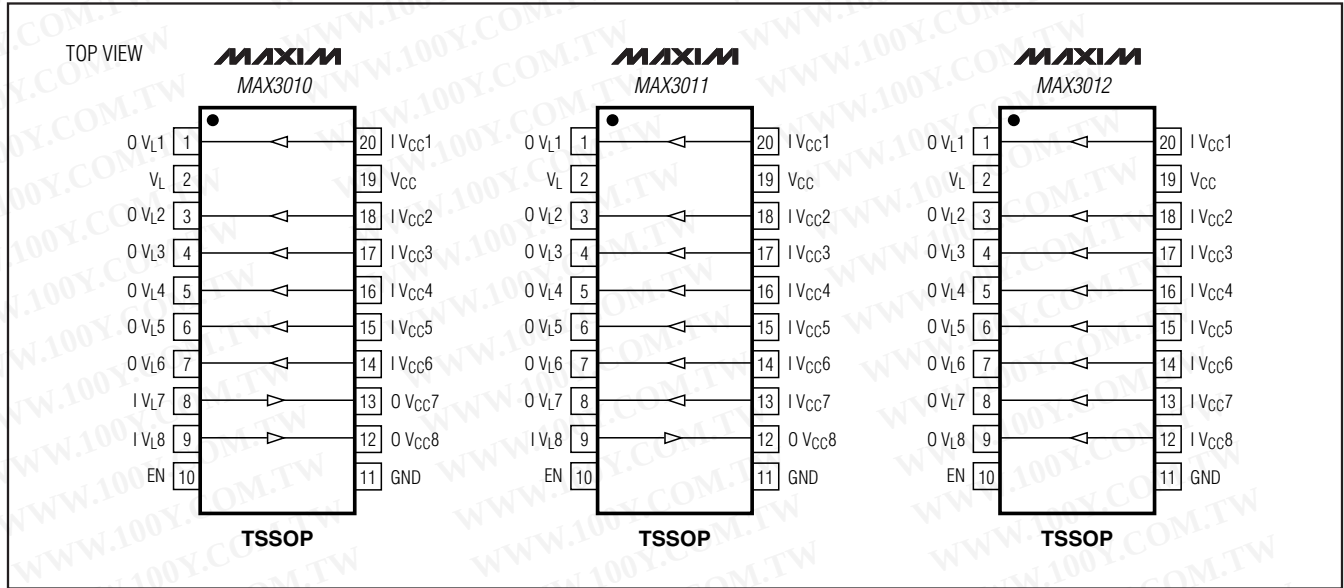
Pin Configurations (continued)



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+1.2V to +5.5V, $\pm 15\text{kV}$ ESD-Protected, $0.1\mu\text{A}$, 35Mbps, 8-Channel Level Translators

Pin Configurations (continued)



Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE
MAX3001E EUP	-40°C to +85°C	20 TSSOP
MAX3001EEBP-T*	-40°C to +85°C	4 x 5 UCSP
MAX3001EETP	-40°C to +85°C	20 TQFN
MAX3001EAUP	-40°C to +125°C	20 TSSOP
MAX3002E EUP	-40°C to +85°C	20 TSSOP
MAX3002EBP-T*	-40°C to +85°C	4 x 5 UCSP
MAX3002ETP	-40°C to +85°C	20 TQFN
MAX3003E EUP	-40°C to +85°C	20 TSSOP
MAX3003EBP-T*	-40°C to +85°C	4 x 5 UCSP
MAX3003ETP	-40°C to +85°C	20 TQFN
MAX3004E EUP	-40°C to +85°C	20 TSSOP
MAX3004EBP-T*	-40°C to +85°C	4 x 5 UCSP
MAX3005E EUP	-40°C to +85°C	20 TSSOP
MAX3005EBP-T*	-40°C to +85°C	4 x 5 UCSP
MAX3006E EUP	-40°C to +85°C	20 TSSOP
MAX3006EBP-T*	-40°C to +85°C	4 x 5 UCSP

PART	TEMP RANGE	PIN-PACKAGE
MAX3007E EUP	-40°C to +85°C	20 TSSOP
MAX3007EBP-T*	-40°C to +85°C	4 x 5 UCSP
MAX3008E EUP	-40°C to +85°C	20 TSSOP
MAX3008EBP-T*	-40°C to +85°C	4 x 5 UCSP
MAX3009E EUP	-40°C to +85°C	20 TSSOP
MAX3009EBP-T*	-40°C to +85°C	4 x 5 UCSP
MAX3010E EUP	-40°C to +85°C	20 TSSOP
MAX3010EBP-T*	-40°C to +85°C	4 x 5 UCSP
MAX3011E EUP	-40°C to +85°C	20 TSSOP
MAX3011EBP-T*	-40°C to +85°C	4 x 5 UCSP
MAX3012E EUP	-40°C to +85°C	20 TSSOP
MAX3012EBP-T*	-40°C to +85°C	4 x 5 UCSP

*Future product—contact factory for availability.

-T = Tape-and-reel package.

Chip Information

TRANSISTOR COUNT: 1184

PROCESS: BiCMOS